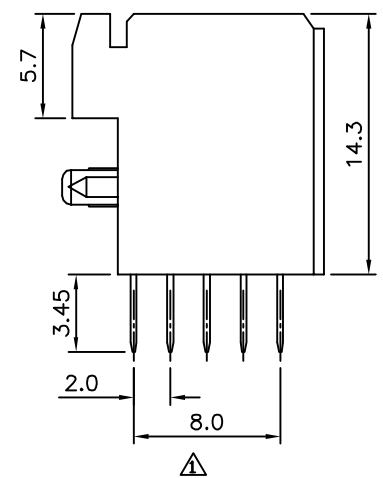


Board To Board Offset Application Example



△ SPECIFICATION

Current Rating: 1 Amp
 Dielectric Withstanding Voltage: AC 1000V For 1 Minute
 Insulation Resistance: 1000 Megaohms Min. At DC 500V
 Contact Resistance: 30 Milliohms Max. At DC 100mA
 Operation Temperature: -55°C ~ +125°C
 Housing: LCP (UL94V-0)
 Contact: Phosphor Bronze
 Gold Plated 10u" On Contact Area, Tin
 Plated On Solder Tails, Over Nickel
 RoHS Compliant

Pin	A	B	C
30	11.95	10.0	0
60	23.95	22.0	12.0
90	35.95	34.0	24.0
120	47.95	46.0	36.0
150	59.95	58.0	48.0
180	71.95	70.0	60.0
210	83.95	82.0	72.0
240	95.95	94.0	84.0

4UCON 元化興業股份有限公司
 4UCON TECHNOLOGY INC.

DRAWING No.		APPROVED BY		UNLESS OTHERWISE SPECIFIED TOLERANCES ARE △ X. ±0.50 .X ±0.25 .XX ±0.15
18244		EMILY		
		CHECKED BY		
		HZF		
		DRAWING BY		
		SONG		
SCALE	NONE	REV.	A1	UNIT mm

NO.	REV.	REVISIONS	CHK	DATE
△ A1		Modify Data	HZF	12/24/2013
△ A0		NEW RELEASE	HZF	03/29/2006